PRODUCT DATASHEET Leila series

last update 10/4/2014

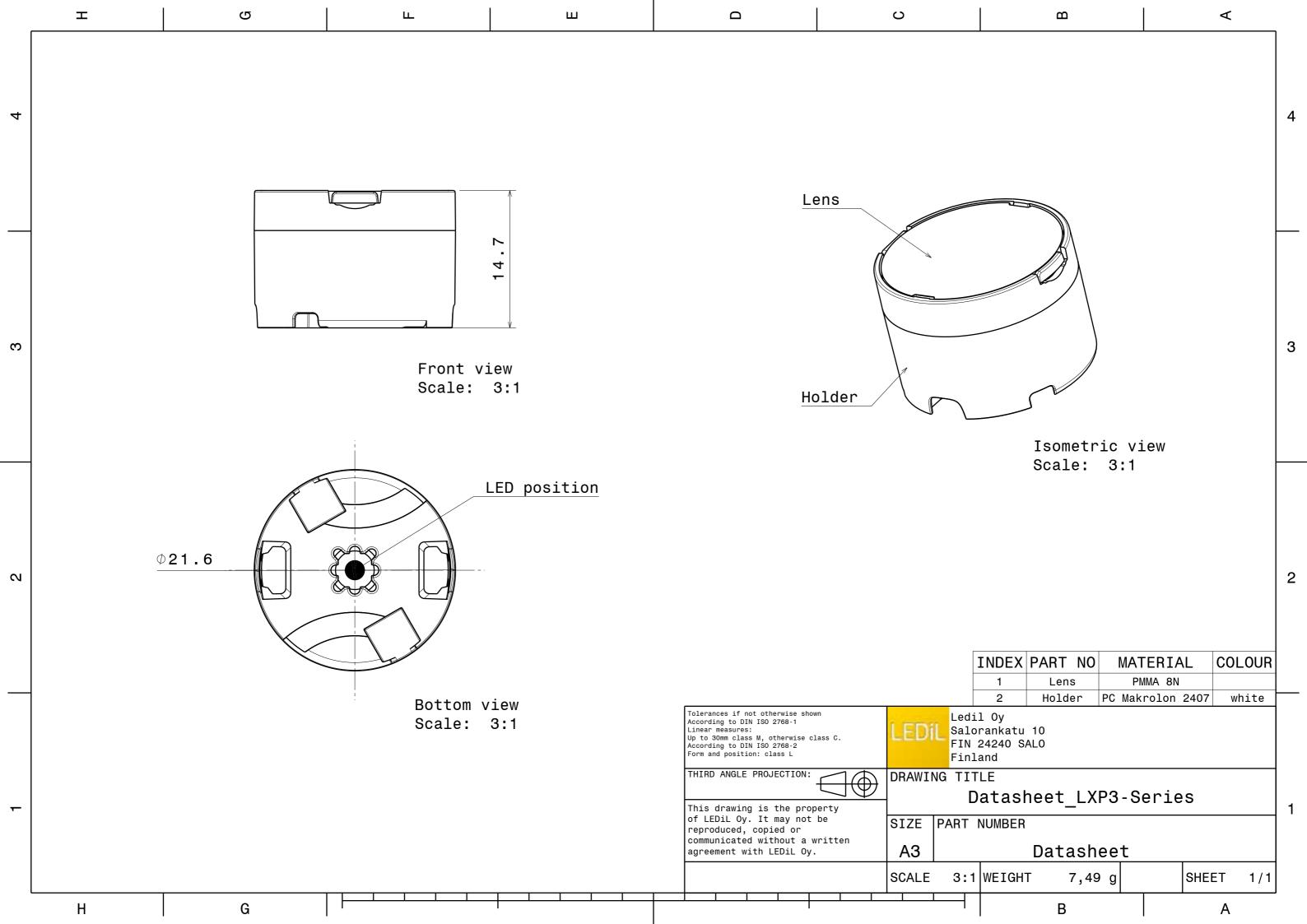
DETAILS

Product Number CP11631_LXP3-RS

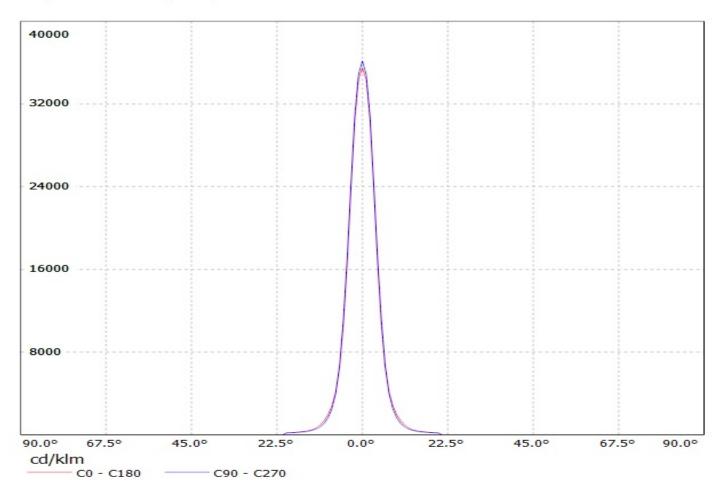
Family Leila Туре Assembly Color white Diameter 21.6 mm Height 14.7 mm Style round **PMMA** Optic Material Holder Material РС Fastening glue Status ready **ROHS** Comliant Yes Date Updated 10/04/2014

OPTICAL PROPERTIES

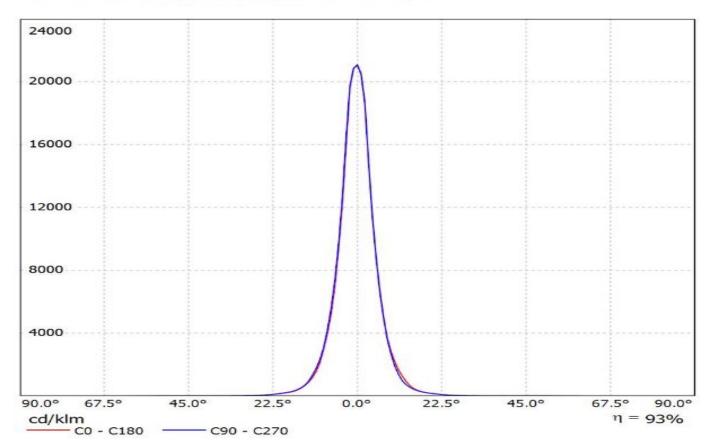
	Viewing	Light	Effi-		
LED	Angle	Beam	ciency	cd/lm	Connector
Z5	sim: 10	Real spot	94 %	-	-
XP-E	7 deg	Real spot	94 %	36.000	-
XP-L HI	9 deg	Real spot	93 %	21.000	-
XP-G	10 dea	Real spot	92 %	16.500	_



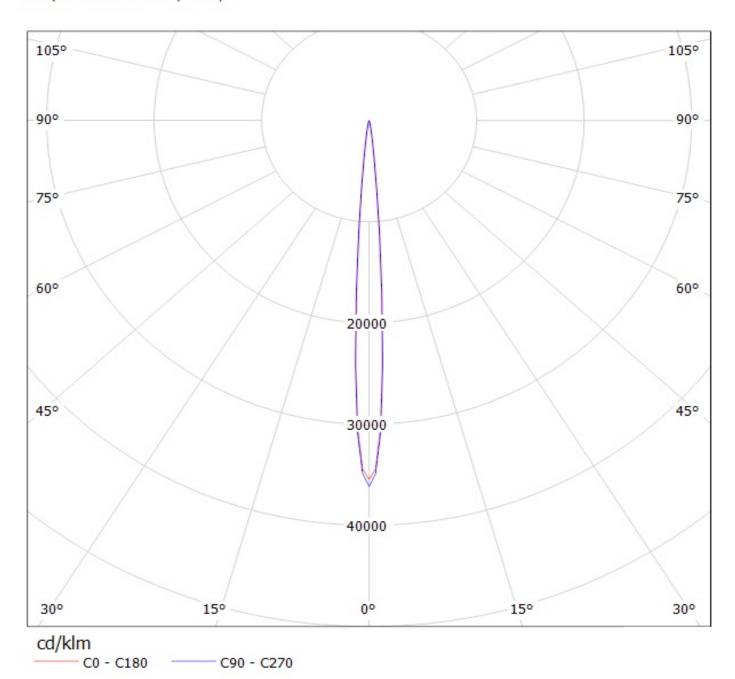
Luminaire: Ledil Oy CP11631_LXP3-RS-XP-E CP11631_LXP3-RS-XP-E Lamps: 1 x Cree XP-E (White)



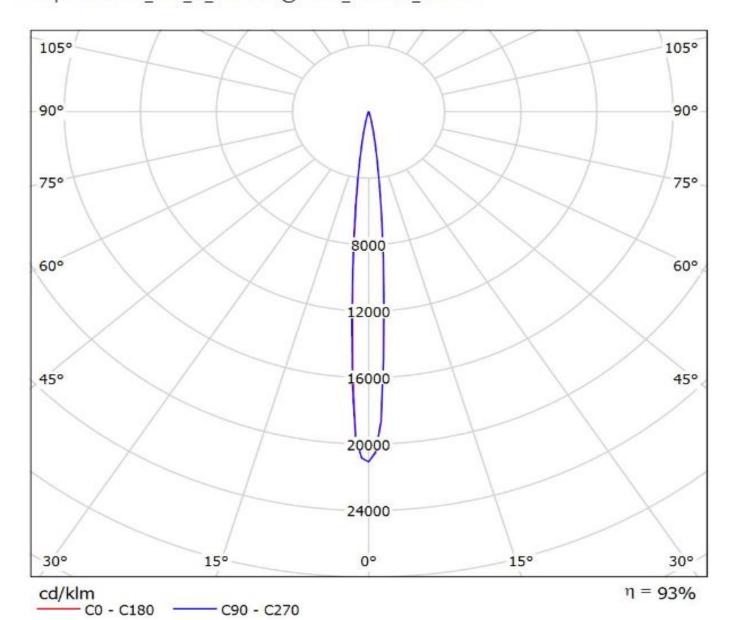
Luminaire: Ledil CP11631_LXP3-RS_(XP-L_HI)
Lamps: 1 x CREE_XP-L_HI_116.971Im@250mA_P=0.75W_I=0.25A



Luminaire: Ledil Oy CP11631_LXP3-RS-XP-E CP11631_LXP3-RS-XP-E Lamps: 1 x Cree XP-E (White)



Luminaire: Ledil CP11631_LXP3-RS_(XP-L_HI)
Lamps: 1 x CREE_XP-L_HI_116.971Im@250mA_P=0.75W_I=0.25A



NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

GENERAL INFORMATION

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet_GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.